Editorial

A decade of ICAE

A decade has passed since I founded the international journal Integrated Computer-Aided Engineering (ICAE) "based on the premise that interdisciplinary thinking and synergistic collaboration of disciplines can solve complex problems, open new frontiers, and lead to true innovations and breakthroughs", as noted in my Editorial in the inaugural issue of the journal published in July 1993. In the same Editorial I also wrote "The focus of ICAE is the integration of leading edge and emerging computer technologies for innovative solution of engineering problems. The journal fosters interdisciplinary research and presents a unique forum for innovative computer-aided engineering (CAE). It will also publish novel industrial applications of CAE, thus helping to bring new computational paradigms from research labs and classrooms to reality."

The interdisciplinary thinking in research advocated by ICAE a decade ago is proven to be the foundation of the innovative research. The journal will continue the same interdisciplinary focus and encourage breaking the traditional boundaries of engineering disciplines and their integration with new and emerging computing and information technologies (IT). The next frontier will be integration of engineering, biomedical sciences, and IT. ICAE is expected to be a leader in this frontier in the coming decade.

A special feature of ICAE is frequent publication of special issues. Among many special issues published during the first decade of publication of the journal, reflecting the breadth and truly interdisciplinary nature of the journal, are

- Object-Oriented Manufacturing Systems
- Artificial Intelligence in Manufacturing and Robotics
- Intelligent Information Systems
- Real-Time Intelligent Control Systems
- Integrated Product and Process Data Management
- Faults in Automated Manufacturing
- Massively Parallel Computing
- Intelligent Manufacturing Systems

- Low Power Electronic Systems
- Design of Embedded Computer Systems
- Real-Time Engineering Systems
- Neural Techniques for Industrial Application
- Distributed Computing and Networking
- Intelligent Autonomous Vehicles
- Architectural Trends for Image Processing and Machine Vision
- Industrial Applications of the Wavelet Transforms
- Agent-Based Manufacturing
- Artificial and Computational Intelligence for Decision, Control, and Automation
- Evolutionary Computing and Neural Networks
- Autonomous and Cooperative Agents for Industry

Publication of special issues continues to be a frequent feature of ICAE. The current issue is devoted to Multi-Sensor Image Processing and Systems. Other planned special issues include

- Engineering Intelligent Systems,
- Multi-Agent Systems
- Climbing Robots,
- Fuzzy Logic,
- Digital Human Modeling,
- Computer Vision/Computer Graphics Collaboration for Model-based Imaging, Rendering, and Image Analysis, and
- Computer-Aided Engineering Methods in Molecular Biology and Drug Design

The manuscripts submitted for possible publication in the journal are reviewed by at least three reviewers selected among the members of the Editorial Advisory Board of the journal and nearly 500 other researchers from many different countries reflecting the true interdisciplinary and international audience of the journal. Many of these reviewers have agreed in advance to review manuscripts for the journal by filling out the journal *Conscientious Reviewer* form. The 348 individuals who have reviewed manuscripts for the journal in re-

cent years are acknowledged at the end of this editorial. Our apologies for names omitted inadvertently, specially those reviewers whose names were not submitted to me by some of the guest editors.

Hojjat Adeli Editor-in-Chief

Janos Abonyi, University of Veszprem, Hungary
Emmanuel D. Adamides, Ecole Polytechnic Federale
de Lausanne, Switzerland
Panagiotis Adamidis, University of Stuttgart, Germany
Sadashiv Adiga, University of California, Berkeley
Stan C. Ahalt, The Ohio State University
Rudolf Albrecht, University of Innsbruck, Austria
Monica Alderighi, IFCTR-CNR, Milan, Italy
Cesare Alippi, Polytechnic of Milan, Italy
Roberto Alonso, Texas A&M University
A. Alpha, University of Manitoba, Canada
Shun-ichi Amari, The Institute of Physical and

Ronald C. Arkin, Georgia Institute of Technology Giorgio Baccarani, University of Bologna, Italy Donald J. Bagert, Texas Tech University Fabrizio Baiardi, University of Pisa, Italy Carlos Balaguer, University of Carlos III, Madrid, Spain

Chemical Research, Japan

Felice Balarin, Cadence Berkeley Laboratories Randolph E. Bank, University of California, San Diego K. Barker, University of Manitoba, Canada Sanjoy Baruah, University of Vermont Steven J. Beaty, Cray Computer Corporation, Colorado Springs

George A. Becus, University of Cincinnati Craig Beebe

Saifallah Benjaafar, University of Minnesota Hamid R. Berenji, Intelligent Inference Systems, USA Pontus Bergsten, Örebro University, Sweden Azer Bestavros, Boston University George Betzos

Giacomo M. Bisio, University of Genova, Italy Snjezana Blagajac, University of Zagreb, Croatia Mark Boddy, Honeywell Technology Center Massimo Bombana, ITALTEL, Milan, Italy Robert Borchelt, University of Wisconsin at Milwaukee

Reda R. Boukezzoula, Université de Savoie, France D. Bradshaw, IBM

Bertil A. Brandin, University of Toronto, Canada Robert W. Brennan, University of Calgary, Canada Jerald R. Brevick, The Ohio State University
M.W. Bright, IBM
S. Brown, University of Tennessee
Alan Burns, University of York
Tiehua Cao, Motorola, Inc.
J. Carruthers, IBM
M. Carson, IBM
Sergio Cavalieri, Politechnico di Milano, Italy
Daniele Caviglia, University of Genova, Italy
D. Chandler, IBM
Y. Chehadeh, Pennsylvania State University
Joseph Chen, Iowa State University
Yeh-Hwa Chen, Georgia Institute of Technology

Republic of China Sunghyun Choi, University of Michigan Wesley Chu, University of California at Los Angeles Andrzej Cichocki, The Institute of Physical and Chemical Research, Japan

Yuh-Min Chen, National Cheng Kung University,

J. Cleetus, West Virginia University Jason Cong

Dario Crosetto, Supercollider Lab, Dallas Cihan Dagli, University of Missouri at Rolla Aldo Dagnino, Transmission Technology Institute, Raleigh, North Carolina

Mario Dal Cin, University of Erlangen, Germany Sivarama Dandamundi, Carleton University, Canada K. Dash, Pennsylvania State University Nigel Davis, Lancaster University, United Kingdom Alessandro De Gloria, University of Genoa, Italy Giovanni DeMicheli, Stanford University Didier Demigny, ENSEA, France Erik de Pablo, Autonomous University of Madrid, Spain

B. Desai, Concordia University, CanadaChris deSilva, University of Western Australia, Australia

Prasun Dewan, Purdue University
Suzanne W. Dietrich, Arizona State University
Tharam Dillon, La Trobe University, Australia
Lisa Cingiser DiPippo, University of Rhode Island
Kevin Dooley, University of Minnesota
Pamela Drew, University of Science and Technology
Debasish Dutta, University of Michigan
Mo Elbestawi, McMaster University, Canada
Janet Efstathiou, University of Oxford, United
Kingdom

M. Eich, Southern Methodist University A. Famili, National Research Council, Canada Shehu Farinwata, American University, Dubai, UAE R. Fauvel, University of Calgary B. M. Ferretti, University of Pavia, Italy B. Finch, IBM

Eric Finch, Gensym Corporation Pamela Fink, Medical Science Systems Gary W. Fischer, University of Iowa Phil Fisher

Martyn Fletcher, Agent Oriented Software, U.K. William Fornaciari, Polytechnic of Milan, Italy Farshad Fotouhi, Wayne State University David Frank

Christian Frey, Universität zu Köln, Germany

O. Frieder, George Mason University

K. Fujimura, The Ohio State University

Brian R. Gaines, University of Calgary, Canada Charles K. Garry, NASA Ames Research Center Eric Gayles

Catherine Gebotys, University of Waterloo, Canada K.M. George, Oklahoma State University Richard Gerber, University of Maryland J. Gerrity, IBM

Alain Girault, INRIA Rhone-Alpes, France Kai Goebel, University of California, Berkeley Robert Goldman, Honeywell Technology Center Forouzan Golshani, Arizona State University E. Gordy, IBM

Marco Gori, University of Siena, Italy Udo Graefe, National Research Council, Canada James Graham, University of Louisville Antonio Grieco, Universita' di Lecce, Italy P. Gu, University of Calgary, Canada

Tut San Guan, Queen Mary and Westfield College, United Kingdom

Hans Hansson, Malardalen University College, Sweden

Jorgen Hansson, University of Skovde, Sweden Salim Hariri, Syracuse University

Scott Harvey, National Institute of Standards, Gaithersburg, Maryland

Hooshang Hemami, The Ohio State University Francisco Herrera, University of Granada, Spain M. Hoferek, IBM

Frank Hoffman, Royal Institute of Technology, Sweden

L. Hollaar, University of Utah

Larry Holloway, University of Kentucky

W. Timothy Holman

Seongsoo Hong, Seoul National University, Korea

T. Horowitz, Hood College

S.H. Hosseini

David Hsiao

Chua-Huang Huang, The Ohio State University

Ken Hughes, University of the Pacific

Shih-Lin Hung, National Chiao Tung University, Republic of China

Dongyoon Hyun, Texas A&M University

Leslie Interrante, University of Alabama, Huntsville

Shahrukh A. Irani, University of Minnesota

Liliana Ironi, Institute of Numerical Analysis, Pavia, Italy

Mary Jane Irwin

Christian Jacob, University of Calgary, Canada

V. Jagannathan, West Virginia University

Roger Jang, National Tsing Hua University, Taiwan

Tomasz Janowski, United Nations University, Macau

Kevin Jeffay, University of North Carolina

Agustin Jimenez, Polytechnic University of Madrid, Spain

Niraj K. Jha

Manuel Jimenez

Robert John, De Montfort University, UK Mathai Joseph, Tata Research Development and

Design Centre, India

Sanjay B. Joshi, Pennsylvania State University

Chia-Feng Juang, National Chung Hsing University, Taiwan

Natalia Juristo, Polytechnic University of Madrid, Spain

B. Anthony Kadrvach

Gail E. Kaiser, Columbia University

Theo Kangsanant, Royal Melbourne Institute of Technology, Australia

Vojislav Kecman, University of Auckland, New Zealand

T. Keefe, Pennsylvania State University

Wisama Khalil, Laboratoire d'Automatique de Nantes, France

Gary L. Kinzel, The Ohio State University

Kiriakos Kiriakidis, United States Naval Academy

Barney Klamechi, University of Minnesota

Mark Klein, Boeing Computing Services

Yves Kodratoff, University of Paris–South, France C.K. Koh

Teuvo Kohonen, Helsinki University of Technology, Finland

Jeff Koller

Philip Koopman, Carnegie Mellon University Mario Koppen, Fraunhofer-Institut IPK Berlin, Germany

R. Korfhage, University of Pittsburgh

David Kortenkamp, NASA Johnson Space Center

Jana Kosecka, University of Pennsylvania

Alexander Kott, Carnegie Group

G.K. Kraetzschmar, Bavarian Research Center for

Knowledge-Based Systems, Germany Sergei V. Kulakov, St. Petersburg Academy of Aerospace, Russia

Soundar R.T. Kumara, Pennsylvania State University Andrew Kusiak, University of Iowa

Rosalba Lamanna de Rocco, University of Simon Bolivar, Venezuela

Tomas Lang

Taiwan

Reza Langari, Texas A&M University Andrew R. LeBlanc, Clemson University

Dik L. Lee, Hong Kong University of Science and Technology, Hong Kong

Insup Lee, University of Pennsylvania

Mark Lee, University of Wales, United Kingdom

Yann-Hang Lee, University of Florida

Pierre Lefrancois, University of Laval, Canada

Wendy Lehnert, University of Massachusetts

Qing Li, University of Science and Technology

Tilo Lilienblum, University of Magdeburg, Germany Chin-Teng Lin, National Chiao-Tung University,

Jane Liu, University of Illinois at Urbana Tingyang Liu

Zhi-Qiang Liu, University of Melbourne, Australia

Peter Loborg, Linkoping University

Doug Locke, Lockheed Martin Corporation

Carl Looney, University of Nevada, Reno

Vicente Lopez, Autonomous University of Madrid, Spain

Sam Lor, Griffith University, Australia

Menahem Lowy

G. Luckenbaugh, IBM

Damian Lyons, North American Philips Corporation

Steven L. Lytinen, DePaul University

Nadia Magnenat Thalmann, University of Geneva, Switzerland

Charles Meissner, University of Michigan

Lorenzo Mezzalira, Polytechnic of Milan, Italy

Les Miller, Iowa State University

Peter Milligan, The Queen's University of Belfast, United Kingdom

Sang Lyul Min, Seoul National University, Korea

Jack Minker, University of Maryland

Toshimi Minoura, Oregon State University

Christian Mittasch, Freiberg University of Technology and Mining, Germany

Al Mok, University of Texas at Austin

Federico Montecchi, University of Pavia, Italy

Jose Monteiro, INESC, Lisbon, Portugal

Benoit Montreuil, Laval University, Canada Bob Morley

George Moschytz, Swiss Federal Institute of

Technology at Zurich, Switzerland

Daniel Mosse, University of Pittsburgh

Joe Moze, Hong Kong University of Science and Technology

Mohamed Shahid Mujtaba, Hewlett-Packard

Sarit Mukherjee, University of Nebraska-Lincoln

Ravi Mukkamala, Old Dominion University

Nicola Muscettola, NASA Ames Research Center Chetana Nagendra

Fazel Naghdi, University of Wollongong, Australia Farid Najm

Tomoharu Nakashima, Osaka Prefecture University, Japan

Wolfgang Nejdl, RWTH Aachen, Germany

Gabor Nemeth, Budapest Technical University, Hungary

Sing Kiong Nguang, University of Auckland, New Zealand

Huy T. Nguyen, Georgia Institute of Technology Henry O. Nyongesa, Sheffield Hallam University, UK

Hiroshi Ohtake I. Olasupo, IBM

Mauro Olivieri, University of Genoa, Italy

Gianni Orlandi, University of Rome "La Sapienza", Italy

Alfonso Ortega

S. Osowski, Technical University of Warsaw, Poland

S. Pakzad, Pennsylvania State University

Rajendran Panda

Marios Papaefthymiou

Christiaan J.J. Paredis, Carnegie Mellon University

Eros Pasero, Polytechnic of Torino, Italy

Ron J. Patton, University of Hull, U.K.

Michal Pechoucek, Czech Technical University, Czech Republic

Massoud Pedram

Witold Pedrycz, University of Alberta, Canada

Huei Peng, University of Michigan

Emil M. Petriu, University of Ottawa, Canada

Marc Pirlot, Polytechnic of Mons, Belgium

Edwige Pissaloux, University of Paris XI, France Reinhard Posch, Graz University of Technology,

Austria

George Potamias, Foundation for Research and Technology (FORTH), Greece

Alberto Prieto, University of Granada, Spain

Miodrag Ptokonjak

Raj Radjassamy

Giancarlo Raiconi, Italy

Srinivasan Ramaswamy, University of Texas at Austin

Ravi M. Rangan

M. Ranganathan, IBM

Michael L. Recce, University College of London, United Kingdom

Nancy Reed, University of Minnesota

Charles Reilly, University of Central Florida

Naphtel Rishe, Florida International University

Arno Ritter, Fraunhofer Institute Manufacturing and Automation, Germany

Pilar Rodriguez, Autonomous University of Madrid, Spain

Kaushik Roy, Purdue University

Shounak Roychowdhury, Oracle Corporation, USA

Stuart H. Rubin, Central Michigan University

Fabrizio Russo, University of Trieste, Italy

P. Sadayappan, The Ohio State University

Miguel A. Salichs, University of Carlos III, Madrid, Spain

Adelio Salsano, University of Rome - Tor Vergata, Italy

Jose M. Sanchez, ITESM, Mexico

Sachin Sapatnekar

Majid Sarrafzadeh

Hara P. Satpathy, University of Texas at Dallas Nello Scarabottolo, Politechnic of Milan, Italy

Herman Schmit

Karsten Schwan, Georgia Institute of Technology

Bettina Schweyer, LLP/CESALP, France

Giacomo R. Sechi, IFCTR-CNR, Milan, Italy

Alex V. Shafarenko, United Kingdom

Michael Shanblatt

Chia Shen, Mitsubishi Electric Research Lab

Mark Shephard, Rensselaer Polytechnic Institute

Chia-Hui Shih, National Cheng Kung University

Heonshik Shin, Seoul National University, Korea

Kang G. Shin, University of Michigan

Yung Shin, Purdue University

B. Shirazi, University of Texas at Arlington

Rajiv Shivpuri, The Ohio State University

Cristina Silvano, University of Brescia, Italy

Rajendra Singh

Mukesh Singhal, University of Kentucky

Christopher Smith, University of Minnesota

Craig Smith, Texas A&M University

Richard Smith, Secure Computer Corporation, USA Yeng Chai Soh, Nanyang Technological University,

Singapore

Oleg Sokolsky, Computer Command & Control Company

Richard M. Soley, Framingham Corporate Center, Massachusetts

Sang Hyuk Son, University of Virginia

Matteo Sonza Reorda, Polytechnic of Torino, Italy

Rogelio Soto, ITESM, Mexico

N. Soundararjan, The Ohio State University

Ben Spaanenburg, University of Groningen, The Netherlands

Otto Spaniol. Aachen University of Technology, Germany

Richard K. Squier, Georgetown University

Sampalli Srinivas, Dalhouise University, Canada

C. Staton, George Mason University

Burkhard Stiller, ETH Zurich, Switzerland

Douglas A. Stuart, University of Texas at Austin

Bogong Su, City University of New York

Mahesh Subramanyan

Roberto Tagliaferri, University of Salerno, Italy

Tomohiro Takagi, Meiji University, Japan

Kazuo Tanaka, The University of Electro-Communications, Japan

M. Templeton, Data Integration

Cecilia Temponi, Southwest Texas State University

R.A. Tharumarajah, Commonwealth Scientific&Industrial Research Organiza., Australia

Hamid Tizhoosh, University of Waterloo, Canada

Charles Traylor

Akhilesh Tyagi

R. Unbehauen, University of Erlangen-Nuremberg, Germany

Susan D. Urban, Arizona State University

Paul Valckenaers, Catholic University of Leuven, Belgium

Mateo Valero, Polytechnic University of Catalunya, Spain

V. Ventore, MITRE Corporation

Sarma Vrudhula, University of Arizona

Hidehiko Wada, Yokogawa Electric Corp., Japan

Scott Walker, University of Calgary, Canada

Fang Wang, Academia Sinica, China

Sarah Wang, Purdue University

Tony Warwick, Quantum Hous, United Kingdom

Lonnie Welch, University of Texas at Arlington

Andy Wellings, University of York

Land S. Wimberley, Lockheed Corporation

Vic Wolfe, University of Rhode Island

Howard Wong-Toi, Cadence Berkeley Laboratories

Bill Wood, University of California, Berkeley

Jie Wood, Florida Atlantic University

Yuefei Xu, National Research Council, Canada

Deyi Xue, University of Calgary, Canada

Roni Yagel, The Ohio State University

Simon Yang, University of Guelph, Canada

C.-H. Yen, Iowa State University

Wang Yi, Uppsala University, Sweden

Sergio Yovine, University of California, Berkeley Emilio Zapata, University of Malaga, Spain Bertrand Zavidovique, University of Paris XI, Orsay,

Xiaokun Zhang, Athabasca University, Canada Yuan F. Zheng, The Ohio State University